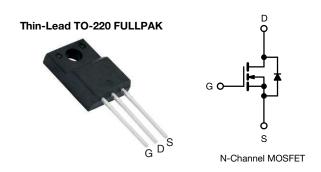
COMPLIANT HALOGEN

**FREE** 

Vishay Siliconix

## **E Series Power MOSFET**



PRODUCT SUMMA	PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	850	)			
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$N_{DS(on)}$ typ. ( $\Omega$ ) at 25 °C $V_{GS} = 10 \text{ V}$ 2.38				
Q <sub>g</sub> max. (nC)	90				
Q <sub>gs</sub> (nC)	11				
Q <sub>gd</sub> (nC)	19				
Configuration	Sing	le			

#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHA2N80E-GE3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unl	less otherwis	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	800	V	
Gate-source voltage			$V_{GS}$	± 30	7 v
Continuous drain surrent (T = 150 °C) 8	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C		2.8	
Continuous drain current (T <sub>J</sub> = 150 °C) <sup>a</sup>	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	1.8	Α
Pulsed drain current <sup>b</sup>			I <sub>DM</sub>	5	
Linear derating factor			0.23	W/°C	
Single pulse avalanche energy <sup>c</sup>		E <sub>AS</sub>	14	mJ	
Maximum power dissipation		P <sub>D</sub>	29	W	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	$T_{J} = 1$	125 °C	al / al.	70	)//
Reverse diode dv/dt d			dv/dt	0.13	- V/ns
Soldering recommendations (peak temperature) e	For	10 s		260	°C
Mounting torque, M3 screw			0.6	Nm	

#### **Notes**

- a. Limited by maximum junction temperature
- b. Repetitive rating; pulse width limited by maximum junction temperature
- c.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_q$  = 25  $\Omega$ ,  $I_{AS}$  = 0.9 A
- d.  $I_{SD} \leq I_D$ , di/dt = 100 A/ $\mu$ s, starting  $T_J$  = 25 °C
- e. 1.6 mm from case



# Vishay Siliconix

THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	$R_{thJA}$	-	65	°C/W
Maximum junction-to-case (drain)	$R_{thJC}$	-	4.3	C/VV

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		800	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	1.0	-	V/°C
Gate-source threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
		V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
7		V <sub>DS</sub> =	800 V, V <sub>GS</sub> = 0 V	-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 640 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 1.0 A	-	2.38	2.75	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	= 30 V, I <sub>D</sub> = 1.0 A	-	1.0	-	S
Dynamic					•		•
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	315	-	pF
Output capacitance	C <sub>oss</sub>	,	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ $f = 1 \text{ MHz}$		20	-	
Reverse transfer capacitance	C <sub>rss</sub>				6	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>DS</sub> = 0 V to 480 V, V <sub>GS</sub> = 0 V		-	13	-	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	45	-	
Total gate charge	Qg			-	9.8	19.6	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 1.0 \text{ A}, V_{DS} = 480 \text{ V}$	-	2.4	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	3.9	-	
Turn-on delay time	t <sub>d(on)</sub>			-	11	22	
Rise time	t <sub>r</sub>	$V_{DD} =$	$V_{DD} = 480 \text{ V}, I_{D} = 1.0 \text{ A}, V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$		7	14	
Turn-off delay time	t <sub>d(off)</sub>				19	38	ns -
Fall time	t <sub>f</sub>				27	54	
Gate input resistance	$R_g$	f = 1 MHz, open drain		1.8	3.6	7.2	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	2.8	
Pulsed diode forward current	I <sub>SM</sub>			-	-	5	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °	C, I <sub>S</sub> = 1 A, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	-		-	278	556	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25$	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 1.0 \text{A},$		0.9	1.8	μC
Reverse recovery current	I <sub>RRM</sub>	dl/dt = 100 A/ $\mu$ s, V <sub>R</sub> = 25 V		_	5	-	A

### Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$  b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

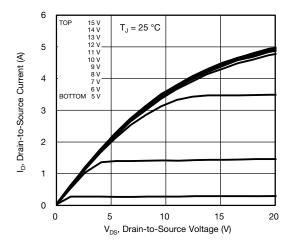


Fig. 1 - Typical Output Characteristics

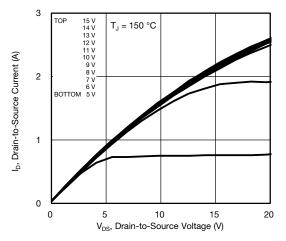


Fig. 2 - Typical Output Characteristics

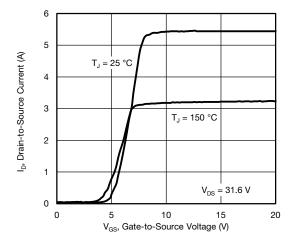


Fig. 3 - Typical Transfer Characteristics

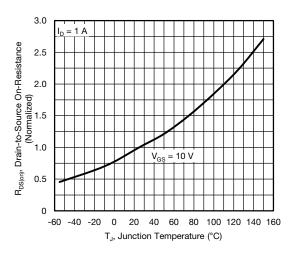


Fig. 4 - Normalized On-Resistance vs. Temperature

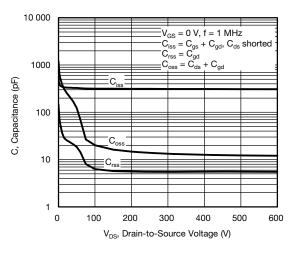


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

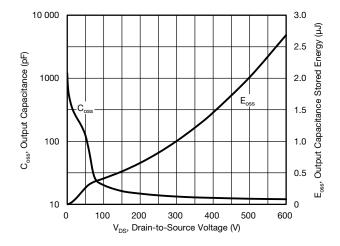


Fig. 6 - Coss and Eoss vs. VDS



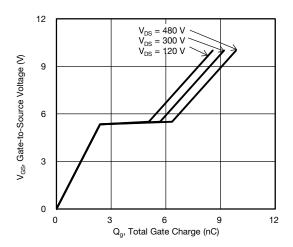


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

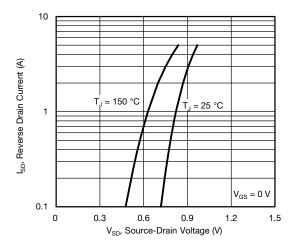


Fig. 8 - Typical Source-Drain Diode Forward Voltage

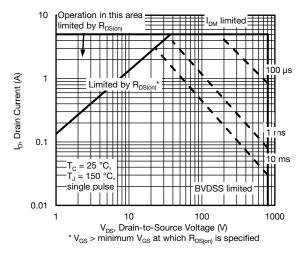


Fig. 9 - Maximum Safe Operating Area

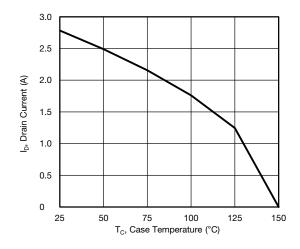


Fig. 10 - Maximum Drain Current vs. Case Temperature

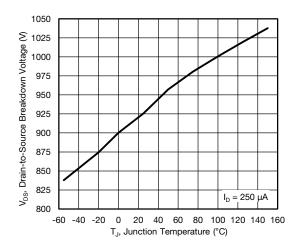


Fig. 11 - Temperature vs. Drain-to-Source Voltage



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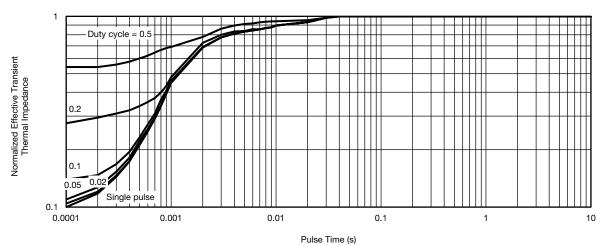


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

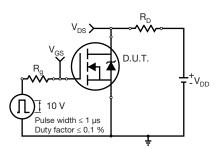


Fig. 13 - Switching Time Test Circuit

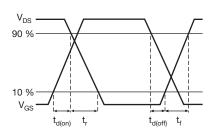


Fig. 14 - Switching Time Waveforms

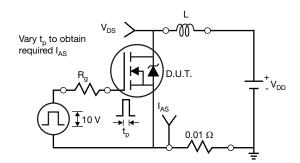


Fig. 15 - Unclamped Inductive Test Circuit

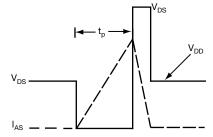


Fig. 16 - Unclamped Inductive Waveforms

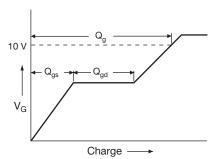


Fig. 17 - Basic Gate Charge Waveform

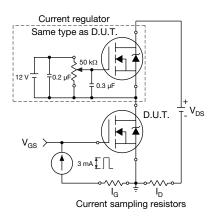
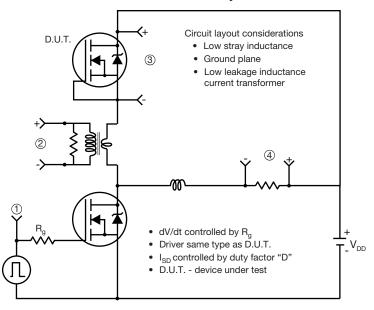


Fig. 18 - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



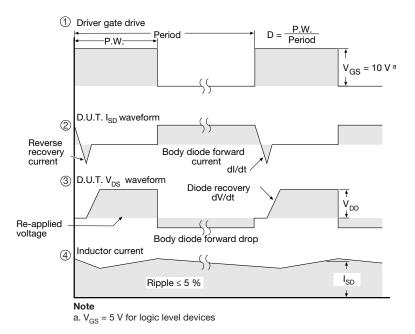
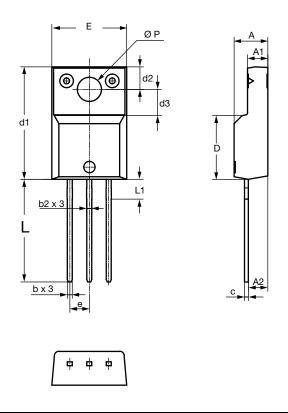


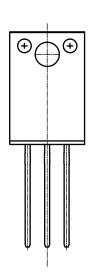
Fig. 19 - For N-Channel

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# **TO-220 FULLPAK Thin Lead**





SYMBOL		DIMEN	ISIONS	
	MILLIN	IETERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
Е	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134

ECN: E20-0684-Rev. D, 28-Dec-2020

DWG: 6021



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Vishay

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